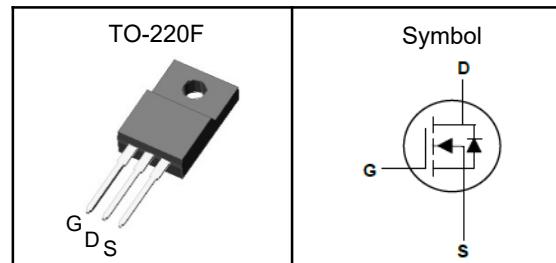


650V Super Junction Power MOSFET

Features

- Low drain-source on-resistance: $R_{DS(ON)}=0.52\Omega(\text{typ})$
- Easy to control gate switching
- Enhancement mode: $V_{th} = 2.5 \text{ to } 4.5V$
- 100% avalanche tested
- RoHS compliant

Pin Description



Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- Charger, Lighting

V_{DSS}	650	V
$R_{DS(ON)-\text{Typ}}$	520	$\text{m}\Omega$
I_D	8	A

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
V_{DSS}	Drain-Source Voltage	650	V
V_{GSS}	Gate-Source Voltage	± 30	V
T_J	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
E_{AS}	Single Pulse Avalanche Energy ^③	156	mJ
$I_{DM}^{①}$	Pulse Drain Current Tested	24	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	8
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	24
			W

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R_{JA}	Thermal Resistance Junction-Ambient ₁	62.5	$^\circ\text{C}/\text{W}$
R_{JC}	Thermal Resistance Junction-Case ₁	5.2	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C .

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

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Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	650	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=650\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	2.5	---	4.5	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 30\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=2.5\text{A}$	---	520	600	$\text{m}\Omega$
Dynamic Characteristics ^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=400\text{V}$, Freq.=1MHz	---	390	---	pF
C_{oss}	Output Capacitance		---	15.2	---	
C_{rss}	Reverse Transfer Capacitance		---	4.43	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DS}}=400\text{V}$, $R_{\text{G}}=10\Omega$, $I_{\text{D}}=2.5\text{A}$	---	7	---	nS
T_r	Turn-on Rise Time		---	8	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	27	---	
T_f	Turn-off Fall Time		---	14	---	
Q_g	Total Gate Charge	$V_{\text{DD}}=400\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=2.5\text{A}$	---	10.5	---	nC
Q_{gs}	Gate-Source Charge		---	2.4	---	
Q_{gd}	Gate-Drain Charge		---	5.1	---	
Source-Drain Characteristics ($T_J=25^\circ\text{C}$)						
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=2.5\text{A}$, $T_J=25^\circ\text{C}$	---	---	1.2	V
t_{rr}	Reverse Recovery Time	$I_{\text{S}}=2.5\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	172	---	nS
Q_{rr}	Reverse Recovery Charge		---	1.2	---	μC

Note ④ : Pulse test (pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

650V Super Junction Power MOSFET

Typical Characteristics

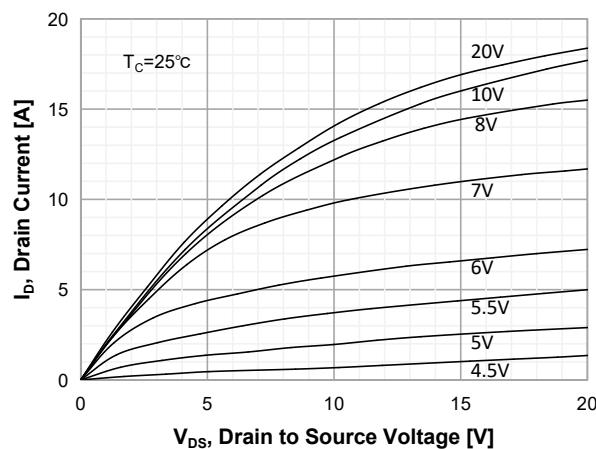


Figure 1. On-Region Characteristics

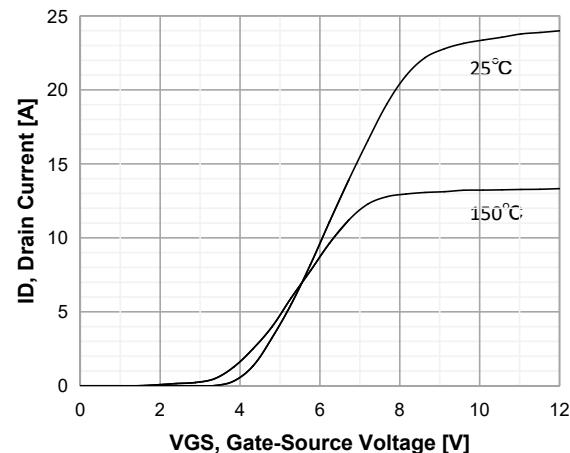


Figure 2. Transfer Characteristics

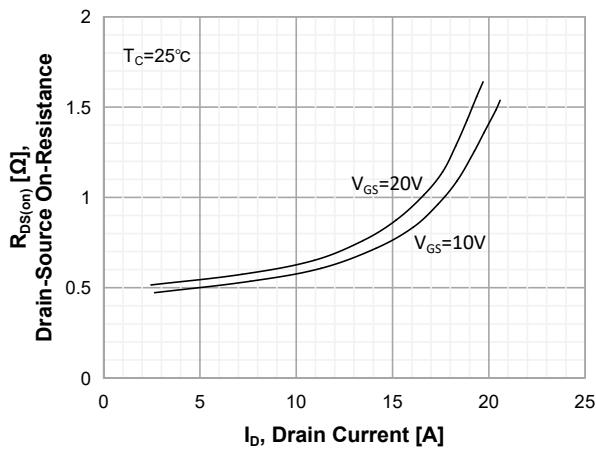


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

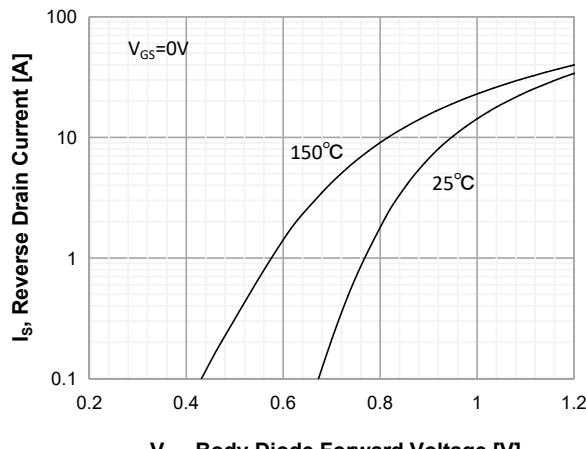


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

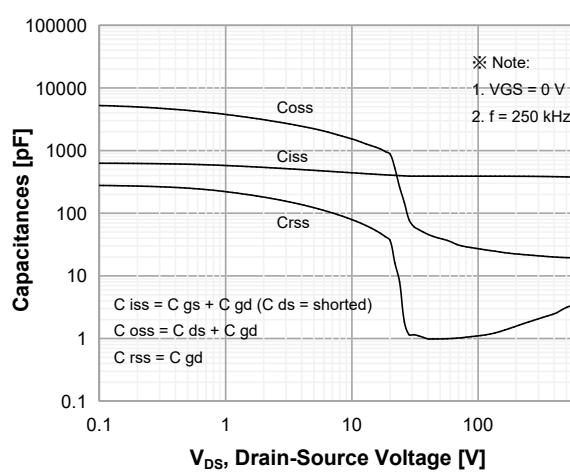


Figure 5. Capacitance Characteristics

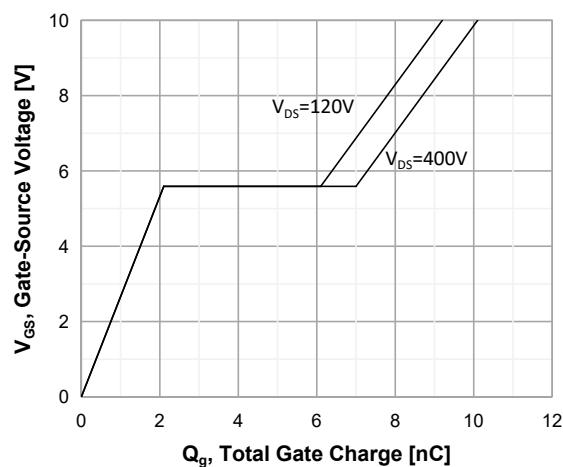


Figure 6. Gate Charge Characteristics

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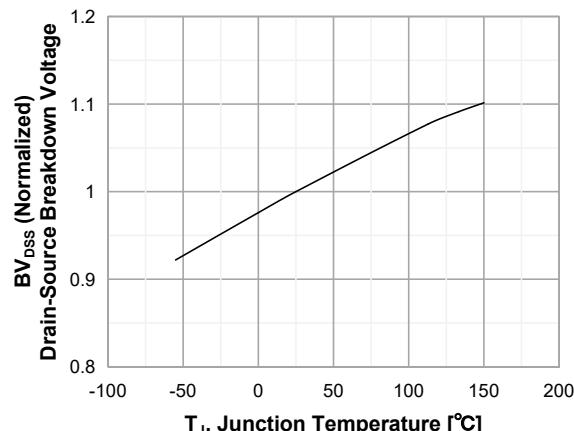


Figure 7. Breakdown Voltage Variation vs Temperature

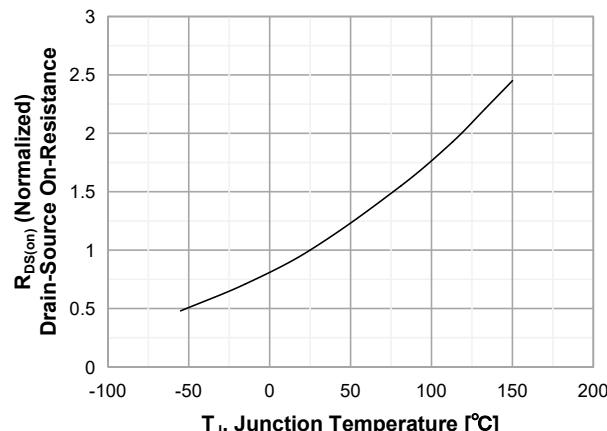


Figure 8. On-Resistance Variation vs Temperature

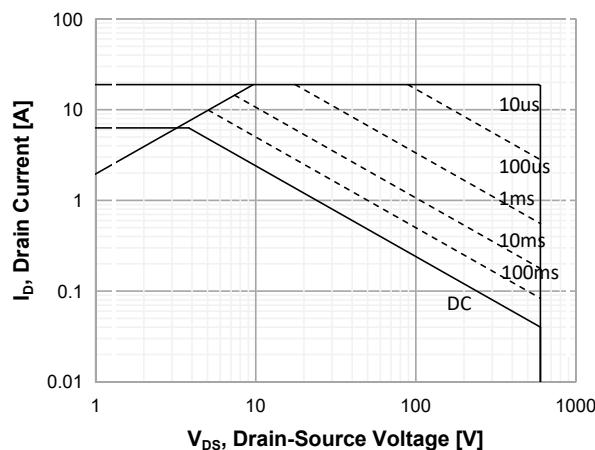


Figure 9. Maximum Safe Operating Area

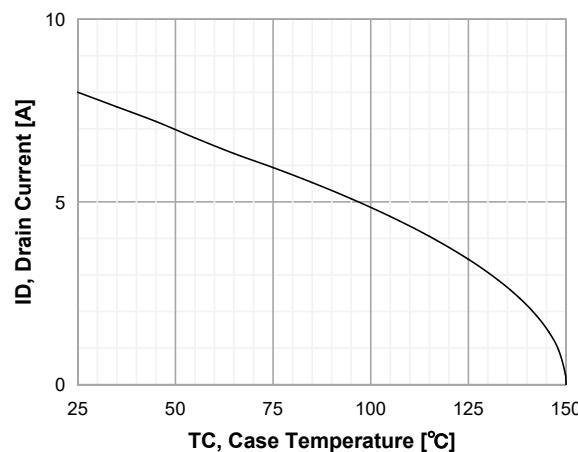


Figure 10. Maximum Drain Current vs. Case Temperature

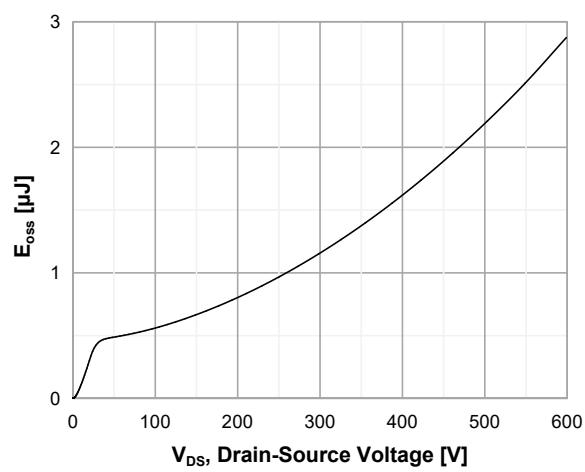


Figure 11.E_{oss} vs. Drain to Source Voltage

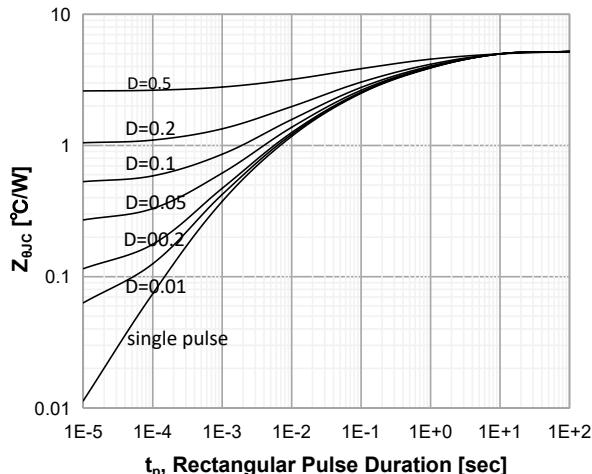


Figure 12.Transient Thermal Response Curve

650V Super Junction Power MOSFET

TO-220F Package Outline Data

